



# STTA2006P/PI

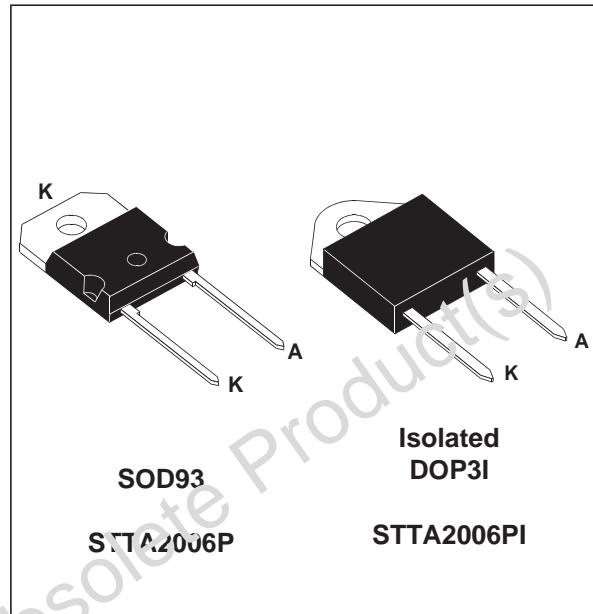
## TURBOSWITCH ULTRA-FAST HIGH VOLTAGE DIODE

### MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	20A
$V_{RRM}$	600V
$t_{rr}$ (typ)	30ns
$V_F$ (max)	1.5V

### FEATURES AND BENEFITS

- SPECIFIC TO "FREEWHEEL MODE" OPERATIONS: FREEWHEEL OR BOOSTER DIODE.
- ULTRA-FAST AND SOFT RECOVERY.
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.
- HIGH FREQUENCY OPERATIONS.
- INSULATED PACKAGE : DOP3I  
Electrical insulation : 2500V<sub>RMS</sub>  
Capacitance < 12 pF



### DESCRIPTION

The TURBOSWITCH is a very high performance series of ultra-fast high voltage power diodes from 600V to 1200V. TURBOSWITCH family, drastically cuts losses in both the diode and the associated switching IGBT or MOSFET in all "freewheel mode" operations

and is particularly suitable and efficient in Motor control freewheel applications and in booster diode applications in power factor control circuitries.

Packaged either in SOD93 or in DOP3I, these

### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		600	V
$V_{RSM}$	Non repetitive peak reverse voltage		600	V
$I_{F(RMS)}$	RMS forward current		50	A
$I_{FRM}$	Repetitive peak forward current	$t_p = 5 \mu s$ $F = 5kHz$ square	270	A
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10 ms$ sinusoidal	180	A
$T_j$	Maximum operating junction temperature		150	°C
$T_{stg}$	Storage temperature range		-65 to 150	°C

TM : TURBOSWITCH is a trademark of STMicroelectronics

**THERMAL AND POWER DATA**

Symbol	Parameter	Test conditions		Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance	SOD93 DOP3I		1.5 2.1	°C/W
$P_1$	Conduction power dissipation $I_{F(AV)} = 20A \quad \delta = 0.5$	SOD93 DOP3I	$T_c = 96^\circ C$ $T_c = 74^\circ C$	36	W
$P_{max}$	Total power dissipation $P_{max} = P_1 + P_3 \quad (P_3 = 10\% P_1)$	SOD93 DOP3I	$T_c = 90^\circ C$ $T_c = 66^\circ C$	40	W

**STATIC ELECTRICAL CHARACTERISTICS**

Symbol	Parameter	Test conditions		Min	Typ	Max	Unit
$V_F^*$	Forward voltage drop	$I_F = 20A$	$T_j = 25^\circ C$ $T_j = 125^\circ C$		1.25	1.75 1.5	V V
$I_R^{**}$	Reverse leakage current	$V_R = 0.8 \times V_{RRM}$	$T_j = 25^\circ C$ $T_j = 125^\circ C$		2.5	100 6	$\mu A$ mA
$V_{to}$	Threshold voltage	$I_p < 3 \cdot I_{AV}$	$T_j = 125^\circ C$			1.15	V
$r_d$	Dynamic resistance					17	m $\Omega$

Test pulse : \*  $t_p = 380 \mu s, \delta < 2\%$   
 \*\*  $t_p = 5 ms, \delta < 2\%$

To evaluate the maximum conduction losses use the following equation :  
 $P = V_{to} \times I_{F(AV)} + r_d \times I_{F(RMS)}^2$

**DYNAMIC ELECTRICAL CHARACTERISTICS**

**TURN-OFF SWITCHING**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$t_{rr}$	Reverse recovery time	$T_j = 25^\circ C$ $I_F = 0.5 A \quad I_R = 1A \quad I_{rr} = 0.25A$ $I_F = 1A \quad dI_F/dt = -50A/\mu s \quad V_R = 30V$		30	60	ns
$I_{RM}$	Maximum reverse recovery current	$T_j = 125^\circ C \quad V_R = 400V \quad I_F = 20A$ $dI_F/dt = -160 A/\mu s$ $dI_F/dt = -500 A/\mu s$		17.5	12.5	A
S factor	Softness factor	$T_j = 125^\circ C \quad V_R = 400V \quad I_F = 20A$ $dI_F/dt = -500 A/\mu s$		0.42		/

**TURN-ON SWITCHING**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$t_{fr}$	Forward recovery time	$T_j = 25^\circ C$ $I_F = 20A, dI_F/dt = 160 A/\mu s$ measured at, $1.1 \times V_{Fmax}$			600	ns
$V_{FP}$	Peak forward voltage	$T_j = 25^\circ C$ $I_F = 20A, dI_F/dt = 160 A/\mu s$			12	V

Fig. 1: Conduction losses versus average current.

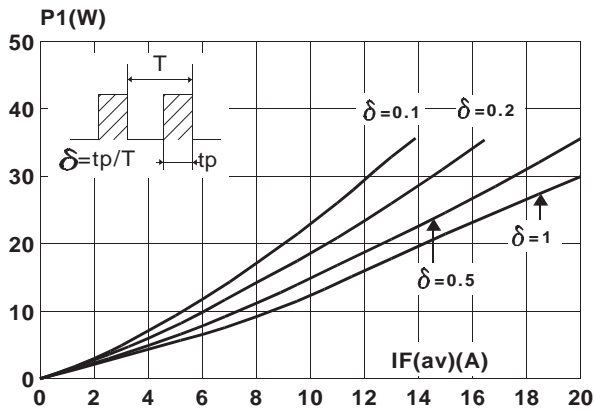


Fig. 2: Forward voltage drop versus forward current.

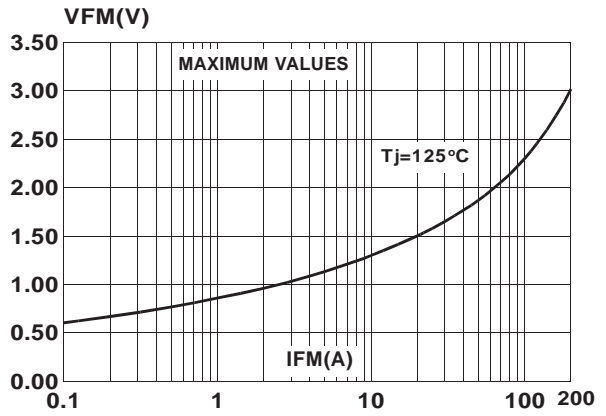


Fig. 3: Relative variation of thermal transient impedance junction to case versus pulse duration.

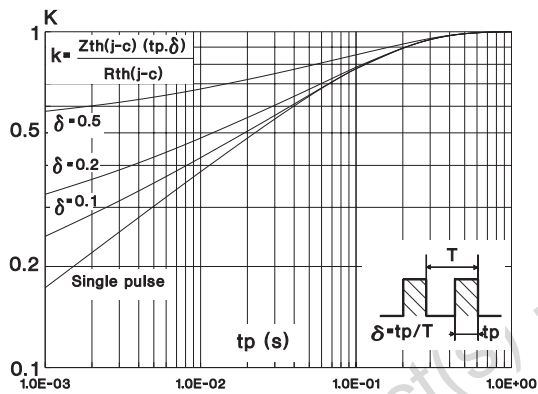


Fig. 4: Peak reverse recovery current versus  $dI_F/dt$ .

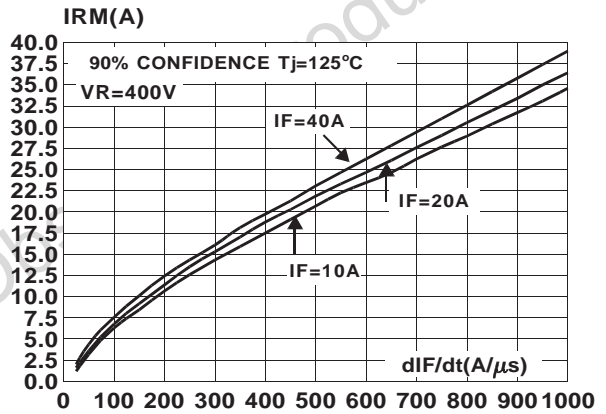


Fig. 5: Reverse recovery time versus  $dI_F/dt$ .

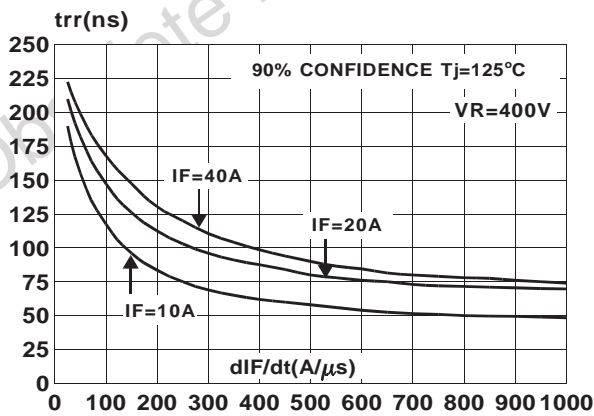


Fig. 6: Softness factor (tb/ta) versus  $dI_F/dt$ .

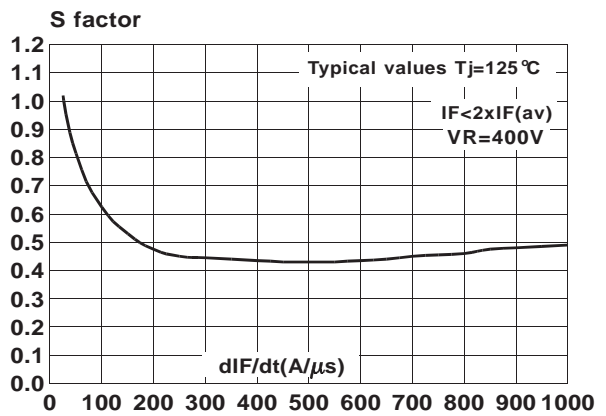


Fig. 7: Relative variation of dynamic parameters versus junction temperature (reference  $T_j=125^\circ\text{C}$ ).

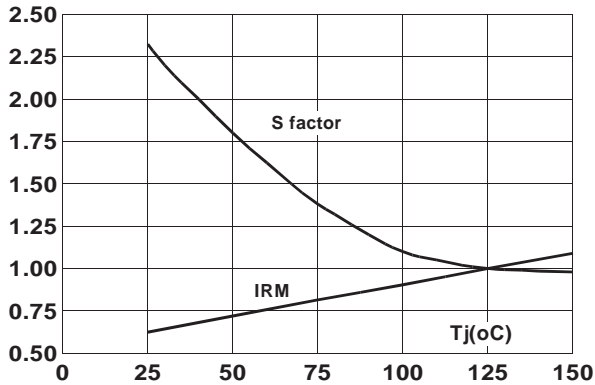


Fig. 9: Transient peak forward voltage versus  $dI_F/dt$ .

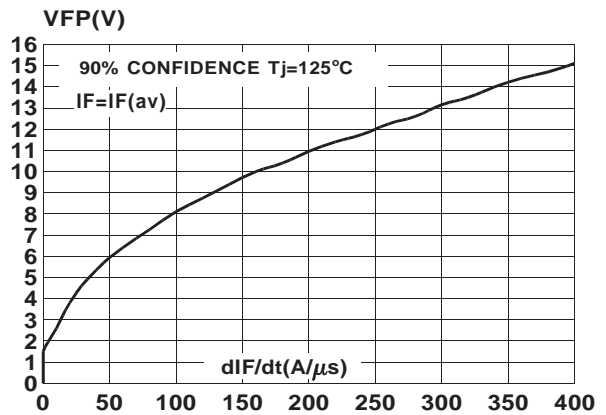
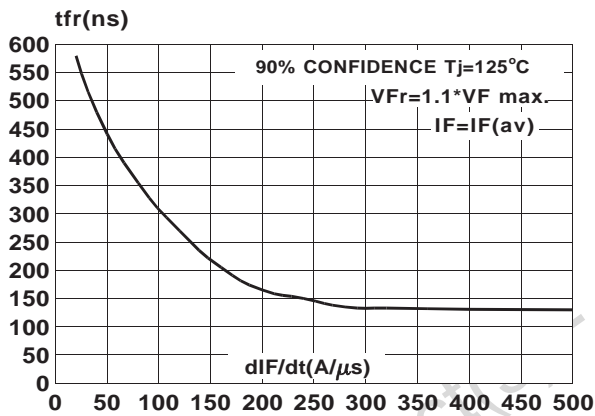


Fig. 9: Forward recovery time versus  $dI_F/dt$ .



Obsolete Product(s)

## APPLICATION DATA

The TURBOSWITCH is especially designed to provide the lowest overall power losses in any "FREEWHEEL Mode" application (Fig.A) considering both the diode and the companion

transistor, thus optimizing the overall performance in the end application. The way of calculating the power losses is given below:

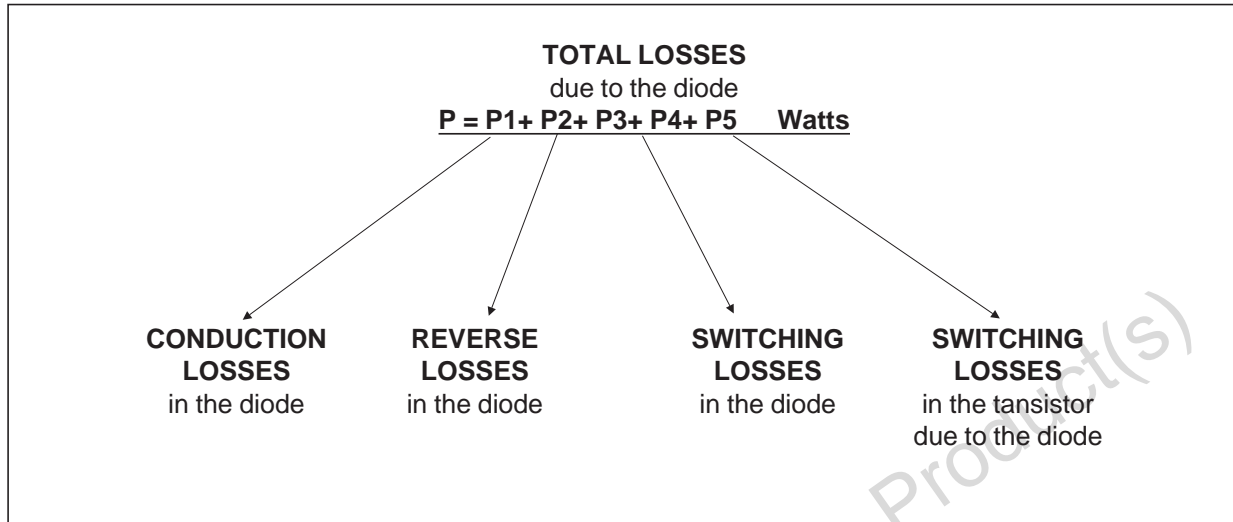
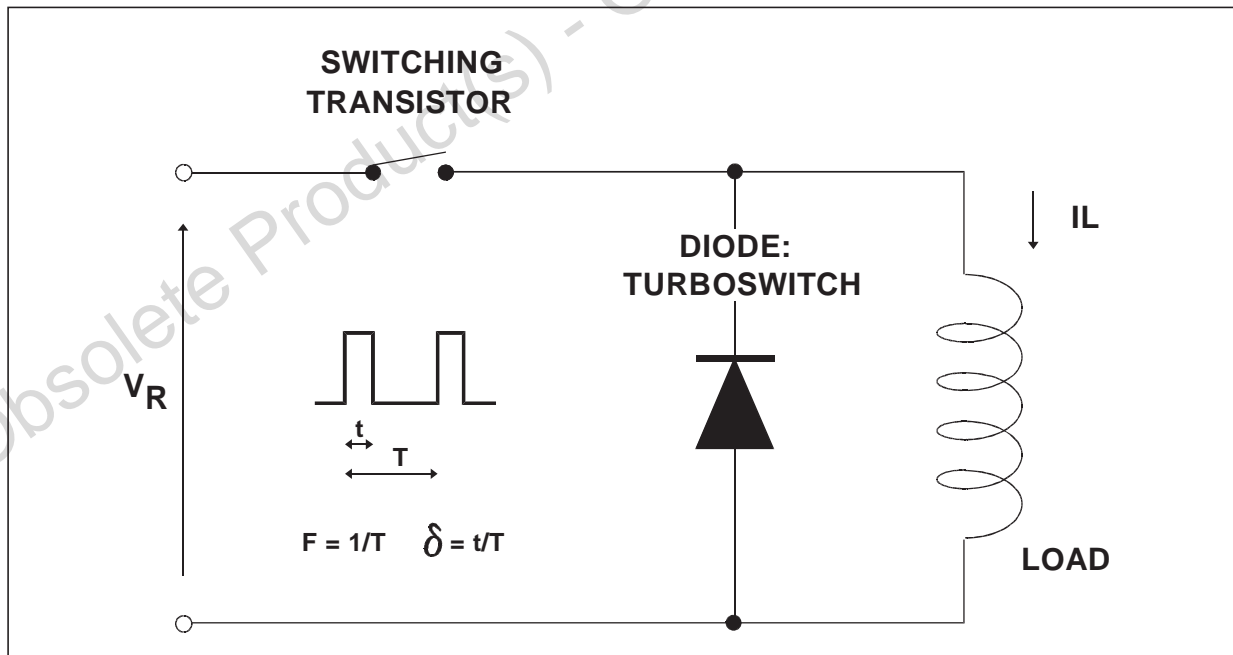
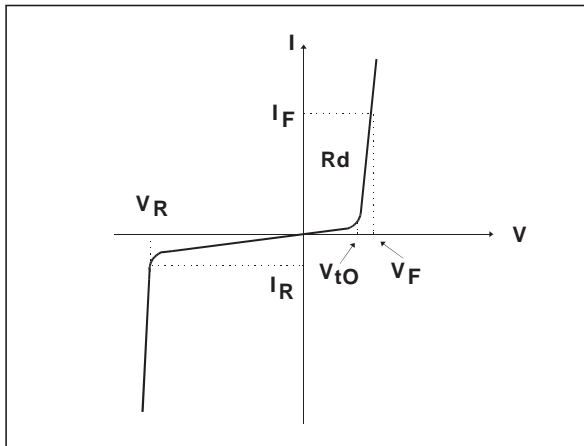


Fig. A : "FREEWHEEL" MODE.



APPLICATION DATA (Cont'd)

Fig. B: STATIC CHARACTERISTICS



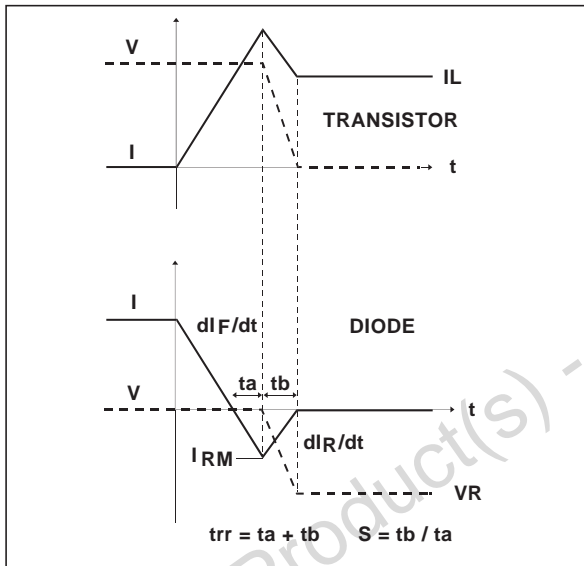
Conduction losses :

$$P1 = V_{t0} \cdot I_{F(AV)} + R_d \cdot I_{F(RMS)}^2$$

Reverse losses :

$$P2 = V_R \cdot I_R \cdot (1 - \delta)$$

Fig. C: TURN-OFF CHARACTERISTICS



Turn-on losses :

(in the transistor, due to the diode)

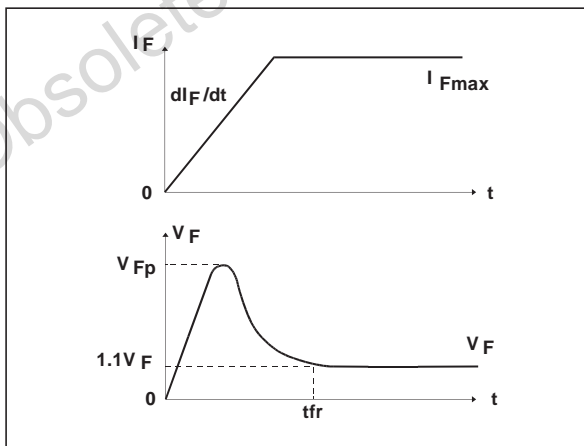
$$P5 = \frac{V_R \times I_{RM}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F / dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F / dt}$$

Turn-off losses (in the diode) :

$$P3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F / dt}$$

P3 and P5 are suitable for power MOSFET and IGBT

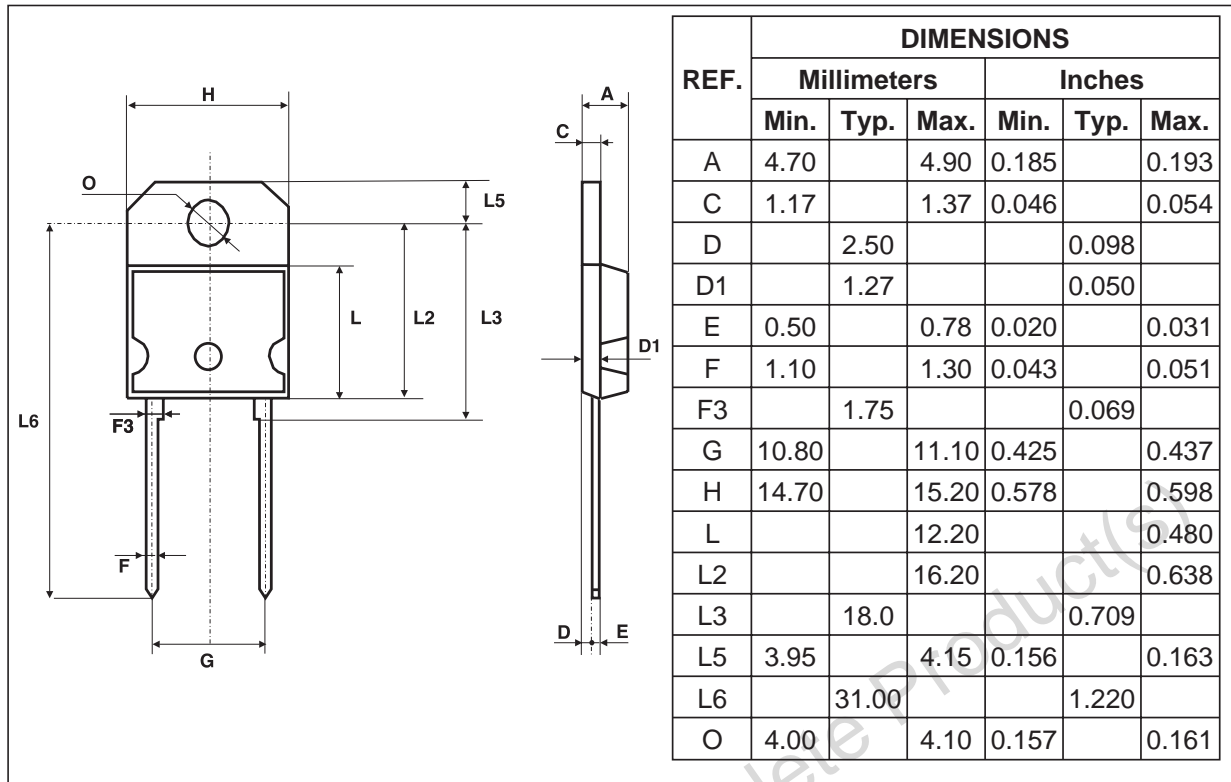
Fig. D: TURN-ON CHARACTERISTICS



Turn-on losses :

$$P4 = 0.4 (V_{FP} - V_F) \cdot I_{Fmax} \cdot t_{fr} \cdot F$$

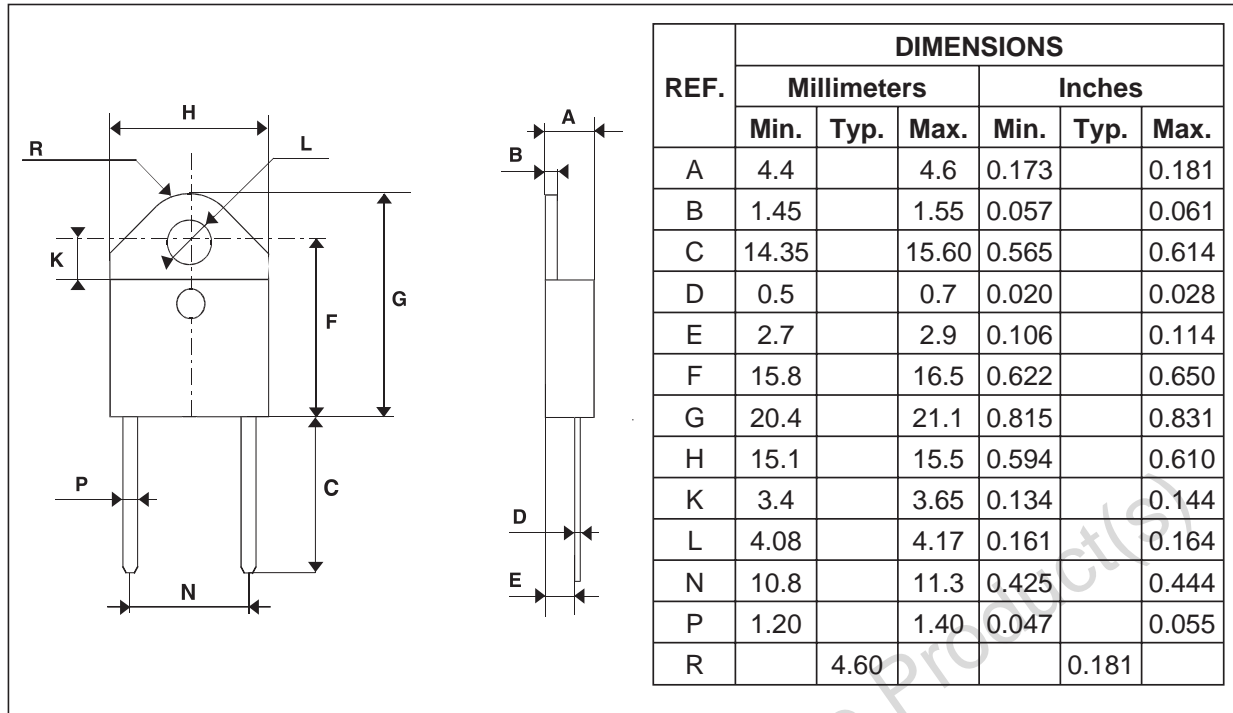
**PACKAGE MECHANICAL DATA**  
SOD93



- Cooling method : by conduction (C)
- Recommended torque value : 0.8 m.N
- Maximum torque value : 1.0 m.N

# STTA2006P/PI

## PACKAGE DATA DOP3I ISOLATED



- Cooling method : by conduction (C)
- Recommended torque value : 0.8 m.N.
- Maximum torque value : 1.0 m.N.

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTA2006P	STTA2006P	SOD93	3.79g	30	Tube
STTA2006PI	STTA2006PI	DOP3I	4.52g	120	Bulk

- Epoxy meets UL94,V0

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